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### 74AHC164

#### **8-BIT PARALLEL-OUT SERIAL SHIFT REGISTERS**

### **Description**

The 74AHC164 is a serial input 8-bit edge-triggered shift register that has outputs from each of eight stages.

#### SERIAL DATA INPUT PINS

The serial input data is entered at pin SDA or pin SDB as these are logically ANDED. Either input could be used as an active HIGH enable with data entry on the other pin. If a single input is desired, the pins can be tied together or the unused input can be tied HIGH.

#### **DATA ENTRY**

Data is shifted into Q0 from the serial input pins on each LOW to HIGH transition of the CP pin. Also during the CP edge the data is transferred from each Qn to Qn+1. The serial data on pins DSA and DSB must be stable before and after the CP rising edge to meet the set-up and hold timing requirements.

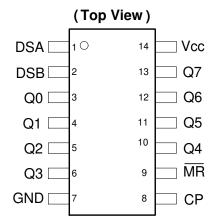
#### RESET

When asserted LOW the Master Reset (MR) pin sets all Qn to LOW. This action does not depend on the condition of serial input or clock pins. The  $\overline{\text{MR}}$  must be asserted HIGH for a recovery time before the next CP positive edge pulse.

#### **Features**

- Wide Supply Voltage Range from 2.0V to 5.5V
- Sinks or Sources 8mA at V<sub>CC</sub> = 4.5V
- CMOS Low Power Consumption
- Schmitt Trigger Action at All Inputs
  - ESD Protection Exceeds JESD 22200-V Machine Model (A115)
    - 2000-V Human Body Model (A114)
    - Exceeds 1000-V Charged Device Model (C101)
- Range of Package Options SO-14 and TSSOP-14
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

### **Pin Assignments**



SO-14 / TSSOP-14 / PDIP-14

### **Applications**

- General Purpose Logic
- Wide Array of Products Such as:
  - PCs, Networking, Notebooks, Netbooks
  - Computer Peripherals, Hard Drives, CD/DVD ROMs
  - TVs, DVDs, DVRs, Set-Top Boxes

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Device ordering information is on page 7



# **Pin Descriptions**

Pin Number	Pin Name	Function
1	DSA	Serial Data Input
2	DSB	Serial Data Input
3	Q0	Data Output
4	Q1	Data Output
5	Q2	Data Output
6	Q3	Data Output
7	GND	Ground
8	CP	Clock Pulse –Positive Edge Triggered
9	MR	Master Reset - Asynchronous
10	Q4	Data Output
11	Q5	Data Output
12	Q6	Data Output
13	Q7	Data Output
14	Vcc	Supply Voltage

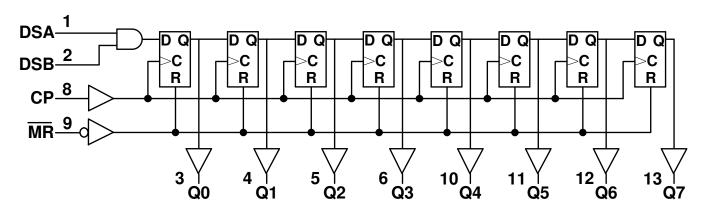
# Function Table (Note 4)

		In	Output			
Mode	MR	СР	DSA	DSB	Q0	Q1-Q7
Reset	L	Х	Х	Х	L	L
	Н	<b>↑</b>	L	Х	L	Qn←Qn-1 (n= 1 to7)
Shift	Н	<b>↑</b>	Х	L	L	Qn←Qn-1 (n= 1 to7)
	Н	<b>↑</b>	Н	Н	Н	Qn←Qn-1 (n= 1 to7)

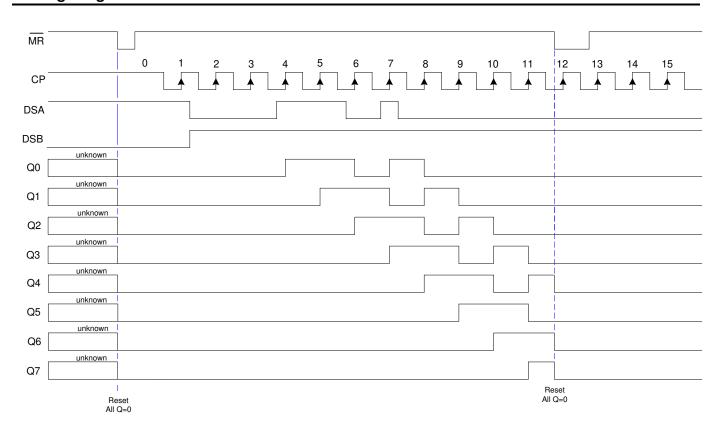
Note: 4. Signals asserted on DSA and DSB must be in place longer than Tsu (set up time) before CP occurs and remain in place Thold (hold time) after CP.



### **Logic Diagram**



# **Timing Diagram**



5. All Q values are reset to LOW when  $\overline{\text{MR}}$  goes low.  $\overline{\text{MR}}$  is asynchronous and overrides all other signals. 6. Serial data supplied at DSA and DSB is ANDED and transferred to Q0 on positive edge of CP. Notes:



# Absolute Maximum Ratings (Note 7) (T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	kV
ESD CDM	Charged Device Model ESD Protection	1	kV
ESD MM	Machine Model ESD Protection	200	V
V <sub>CC</sub>	Supply Voltage Range	-0.5 to +7.0	V
$V_{I}$	Input Voltage Range (Note 8)	-0.5 to +7.0	V
I <sub>IK</sub>	Input Clamp Current V <sub>I</sub> < -0.5V	-20	mA
lok	Output Clamp Current Vo < -0.5V or Vo > Vcc +0.5V	±20	mA
Io	Continuous Output Current -0.5V < V <sub>O</sub> V <sub>CC</sub> +0.5V	±25	mA
Icc	Continuous Current Through Vcc	75	mA
I <sub>GND</sub>	Continuous Current Through GND	-75	mA
TJ	Operating Junction Temperature	-40 to +150	°C
T <sub>STG</sub>	Storage Temperature	-65 to +150	°C
P <sub>TOT</sub>	Total Power Dissipation	500	mW

Notes:

## Recommended Operating Conditions (Note 9) (T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Max	Unit
Vcc	Supply Voltage	=	2.0	5.5	V
VI	Input Voltage	=	0	5.5	V
Vo	Output Voltage	-	0	V <sub>CC</sub>	V
Δt/ΔV	Input Transition Rise or Fall Rate	$V_{CC} = 3.0V \text{ to } 3.6V$	-	100	ns/V
ΔυΔν	Input Transition rise of Fall Rate	V <sub>CC</sub> = 4.5V to 5.5V	-	20	IIS/V
T <sub>A</sub>	Operating Free-Air Temperature	-	-40	+125	°C

Note: 9. Unused inputs should be held at  $V_{\text{CC}}$  or Ground.

<sup>7.</sup> Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.

be within recommend values.

8. Input Voltage cannot exceed Vcc to the extent the Maximum clamp current is exceeded.



# **Electrical Characteristics** ( $T_A = +25^{\circ}C$ , unless otherwise specified.)

Symbol Parameter		Test	V <sub>CC</sub>	Т	<sub>A</sub> = +25°C			0°C to	T <sub>A</sub> = -40°C	to +125°C	Unit
-		Conditions		Min.	Тур.	Max.	Min.	Max.	Min.	Max.	
	I Bala Laval		2.0V	1.5	-	-	1.5	-	1.5	-	
$V_{IH}$	High-Level Input Voltage	-	3.0V	2.1	-	-	2.1	-	2.1	-	V
	input voitage		5.5V	3.85	-	-	3.85	-	3.85	-	
	1 11		2.0V	-	-	0.5	-	0.5	-	0.5	
$V_{IL}$	Low-Level Input Voltage	-	3.0V	-	-	0.9	-	0.9	-	0.9	٧
	input voitage		5.5V	-	-	1.65	-	1.65	=	1.65	
		I <sub>OH</sub> = -50μA	2.0V	1.9	2.0	-	1.9	-	1.9	-	- V
		I <sub>OH</sub> = -50μA	3.0V	2.9	3.0	-	2.9	-	2.9	-	
$V_{OH}$	High-Level Output Voltage	I <sub>OH</sub> = -50μA	4.5V	4.4	4.5	-	4.4	-	4.4	-	
	Output Voltage	I <sub>OH</sub> = -4.0mA	3.0V	2.58	-	-	2.48	-	2.40	-	1
		I <sub>OH</sub> = -8mA	4.5	3.94	-		3.80	-	3.70	-	
		$I_{OL} = 50\mu A$	2.0V	-	0	0.1	-	0.1	-	0.1	
		$I_{OL} = 50\mu A$	3.0V	-	0	0.1	-	0.1	-	0.1	1
$V_{OL}$	Low-Level Output Voltage	$I_{OL} = 50\mu A$	4.5V	-	0	0.1	-	0.1	-	0.1	V
	Output Voltage	I <sub>OL</sub> = 4mA	3.0V	-	0.15	0.36	-	0.44	-	0.55	1
		I <sub>OL</sub> = 8mA	4.5V	-	0.15	0.36	-	0.44	-	0.55	1
lı	Input Current	V <sub>I</sub> = GND or 5.5V	0V or 5.5V	-	-	±0.1	-	± 1	-	± 2	μΑ
Icc	Supply Current	$V_{I} = GND \text{ or } V_{CC}, I_{O} = 0A$	5.5V	-	-	4.0	-	40	-	80	μΑ



# **Switching Characteristics**

Symbol /		Test			T <sub>A</sub> = +25°C		-40°C to	+85°C	-40°C to	+125°C	Unit
Parameter	Pins	Conditions Figure 1	V <sub>cc</sub>	Min	Тур.	Max	Min	Max	Min	Max	
f		C <sub>L</sub> = 15pF	3.0V to	80	125	-	65	-	50	-	
f <sub>MAX</sub> Maximum	СР	C <sub>L</sub> = 50pF	3.6V	50	75	-	45	-	35	-	MHz
Frequency	O.	$C_L = 15pF$	4.5V to	125	175	-	105	-	85	-	1711 12
		C <sub>L</sub> = 50pF	5.0V	85	115	-	75	-	65	-	
	CP HIGH or		3.0V to 3.6V	5.0	-	-	5.0	-	5.0	-	ns
t <sub>w</sub>	LOW	-	4.5V to 5.0V	5.0	-	-	5.0	-	5.0	-	115
Pulse Width	<del></del>		3.0V to 3.6V	5.0	-	-	5.0	-	5.0	-	
MR LOW	-	4.5V to 5.0V	5.0	-	-	5.0	-	5.0	-	ns	
t <sub>su</sub>	DSA or		3.0V to 3.6V	5.0	-	-	6.0	-	6.0	-	
Set-up Time DSB to C	DSB to CP	-	4.5V to 5.0V	4.5	-	-	4.5	-	4.5	-	ns
t <sub>H</sub>	DCA au		3.0V to 3.6V	1.5	-	-	1.5	-	1.5	-	
Hold Time	DSA or	-	4.5V to 5.0V	2.0	-	-	2.0	-	2.0	-	ns
$t_{rec}$	MR to CP		3.0V to 3.6V	2.5	-	-	2.5	-	2.5	-	
RecoveryTime	MR to CP	-	4.5V to 5.0V	2.5	-	-	2.5	-	2.5	-	ns
		C <sub>L</sub> = 15pF	3.0V to	-	6.5	12.8	1.0	15.0	1.0	16.0	
	OD + 0	C <sub>L</sub> = 50pF	3.6V	-	9.3	16.3	1.0	18.5	1.0	20.5	
t <sub>PD</sub>	CP to Qn	C <sub>L</sub> = 15pF	4.5V to	-	4.5	9.0	1.0	10.5	1.0	11.5	ns
Propagation		C <sub>L</sub> = 50pF	5.0V	-	6.4	11.0	1.0	12.5	1.0	14.0	
Delay		C <sub>L</sub> = 15pF	3.0V to	-	5.3	12.8	1.0	15.0	1.0	16.0	
	<del></del>	C <sub>L</sub> = 50pF	3.6V	-	7.6	16.3	1.0	18.5	1.0	20.5	
	MR to Qn	C <sub>L</sub> = 15pF	4.5V to	-	4.0	8.6	1.0	10.0	1.0	11.0	ns
		C <sub>L</sub> = 50pF	5.0V	-	5.8	10.6	1.0	12.0	1.0	13.5	

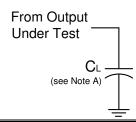
# **Operating Characteristics** (T<sub>A</sub> = +25°C, unless otherwise specified.)

Parameter		Test Conditions	V <sub>CC</sub> = 5.5	Unit	
		rest Conditions	Тур	Maximum	Oilit
C <sub>pd</sub>	Power Dissipation Capacitance per Gate	f = 1 MHz	51	-	pF
Cı	Input Capacitance	$V_I = V_{CC}$ or GND	3	10	pF

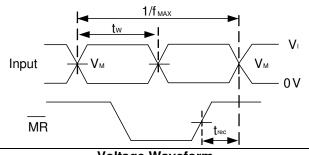
Vcc



### **Parameter Measurement Information**

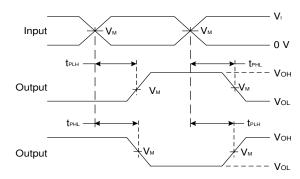


V <sub>CC</sub>	Inputs		V <sub>M</sub>	CL	
	VI	t <sub>r</sub> /t <sub>f</sub>		- L	
3.0V-3.6V	V <sub>CC</sub>	≤3ns	V <sub>CC</sub> /2	15pF,50pF	
4.5V-5.5V	V <sub>CC</sub>	≤3ns	V <sub>CC</sub> /2	15pF,50pF	



Voltage Waveform
Pulse Duration and Recovery Time

Voltage Waveform Set-up and Hold Times



Voltage Waveform
Propagation Delay Times
Inverting and Non Inverting Outputs

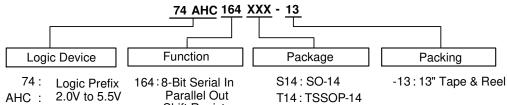
Notes: A. Includes test lead and test apparatus capacitance.

- B. All pulses are supplied at pulse repetition rate ≤10 MHz.
- C. Inputs are measured separately one transition per measurement.
- D.  $t_{\text{PLH}}$  and  $t_{\text{PHL}}$  are the same as  $t_{\text{PD.}}$

Figure 1 Load Circuit and Voltage Waveforms



### **Ordering Information**



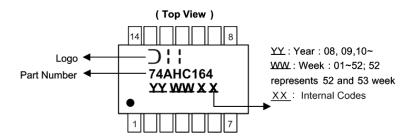
Parallel Out AHC: T14: TSSOP-14

Shift Register Family D14: PDIP-14

Device	Bookaga Cada	Dookoging	Pac	king
Device	Package Code	Packaging	Quantity	Part Number Suffix
74AHC164S14-13	S14	SO-14	2,500/Tape & Reel	-13
74AHC164T14-13	T14	TSSOP-14	2,500/Tape & Reel	-13
74AHC164D14	D14	PDIP-14	Tube	

## **Marking Information**

#### (1) SO-14, TSSOP-14, PDIP-14



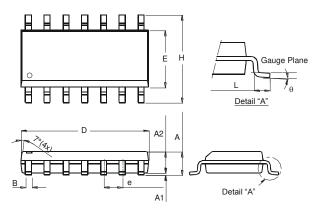
Part Number	Package
74AHC164S14-13	SO-14
74AHC164T14-13	TSSOP-14
74AHC164D14	PDIP-14



### Package Outline Dimensions (All dimensions in mm.)

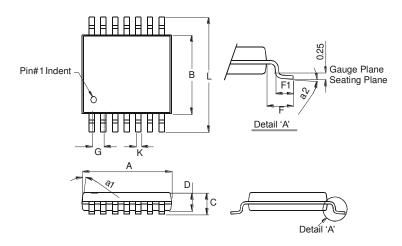
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

### Package Type: SO-14



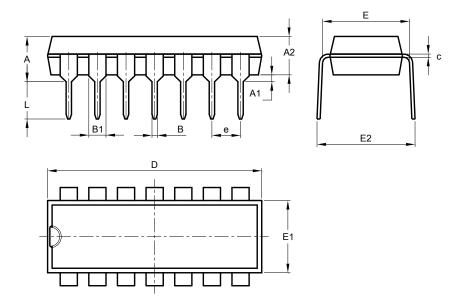
	SO-14							
Dim	Min	Max						
Α	1.47	1.73						
<b>A</b> 1	0.10	0.25						
A2	1.45	Тур						
В	0.33	0.51						
D	8.53	8.74						
Е	3.80	3.99						
е	1.27	Тур						
Н	5.80	6.20						
L	0.38	1.27						
θ	0°	8°						
All Dimensions in mm								

### Package Type: TSSOP-14



	TSSOP-1	4				
Dim	Min	Max				
a1	7° (	4X)				
a2	0°	8°				
Α	4.9	5.10				
В	4.30	4.50				
C		1.2				
D	8.0	1.05				
F	1.00	Тур				
F1	0.45	0.75				
G	0.65	Тур				
K	0.19	0.30				
L	L 6.40 Typ					
All Dir	nensions	s in mm				

### Package Type: PDIP-14



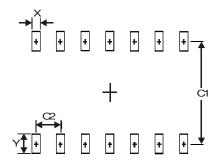
PDIP-14			
Dim	Min	Max	
Α	3.710	4.310	
<b>A</b> 1	0.510	-	
A2	3.200	3.600	
В	0.380	0.570	
B1	1.524 (BSC)		
С	0.204	0.360	
D	18.800	19.200	
Е	6.200	6.600	
E1	7.320	7.920	
E2	8.400	9.000	
е	2.540 (BSC)		
Ĺ	3.000	3.600	
All Dimensions in mm			



### **Suggested Pad Layout**

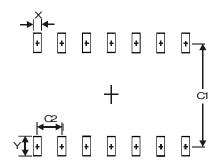
Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

### Package Type: SO-14



Dimensions	Value (in mm)
Х	0.60
Υ	1.50
C1	5.4
C2	1.27

### Package Type: TSSOP-14



Dimensions	Value (in mm)	
Х	0.45	
Υ	1.45	
C1	5.9	
C2	0.65	



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